

# Specification For UV Series

## HPL-H44RU1C0



### Features

- High Efficacy 3W UV LED
- Dimension : 4.4mm(L)×4.4mm(W)
- All Metal Design Cu Substrate/ Al reflector with Quartz Glass Lens
- View Angle 60°
- Low thermal resistance
- The InGaN Chip inside
- Superior ESD protection

### Applications

- UV Printing/UV Curing
- Medical
- Electronics Assembly
- Opto Electronics
- Special Lighting
- Defect Detection

5F, No 173-8, Yung-Fon Road, Tu-Cheng District, New Taipei City, Taiwan, R.O.C.  
TEL: +886-2-8262-8886      FAX : +886-2-8262-8885

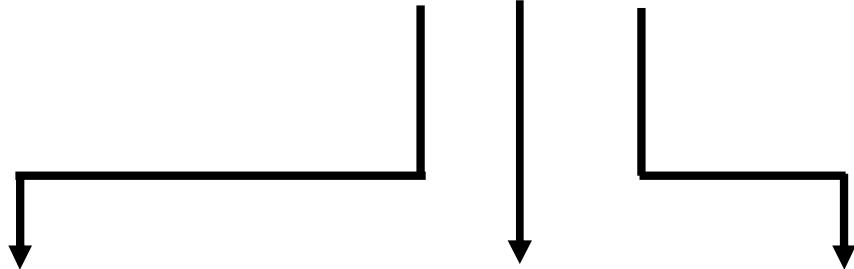


## Table of Contents

|                                                         |    |
|---------------------------------------------------------|----|
| <b>General Information</b> .....                        | 3  |
| <b>Part Number Matrix</b> .....                         | 4  |
| <b>Absolute Maximum Ratings</b> .....                   | 4  |
| <b>Initial Electrical/Optical Characteristics</b> ..... | 5  |
| <b>Forward Voltage</b> .....                            | 5  |
| <b>Radiant Flux</b> .....                               | 5  |
| <b>Peak Wavelength</b> .....                            | 5  |
| <b>Spectra half-width</b> .....                         | 5  |
| <b>Typical Radiation Pattern</b> .....                  | 6  |
| <b>Bin Code List for Reference</b> .....                | 7  |
| <b>Wavelength Bins</b> .....                            | 7  |
| <b>Part Number Formation</b> .....                      | 8  |
| <b>Characteristic Diagram</b> .....                     | 9  |
| <b>Outline Dimension</b> .....                          | 13 |
| <b>Pad Configuration</b> .....                          | 13 |
| <b>Recommended Solder Pattern</b> .....                 | 15 |
| <b>Shipping Package Style</b> .....                     | 16 |
| <b>Lens Type</b> .....                                  | 16 |
| <b>Tapping Dimension Packaging Specification</b> .....  | 16 |
| <b>Assembly Type</b> .....                              | 21 |
| <b>Tapping Dimension Packaging Specification</b> .....  | 21 |
| <b>Qualification Reliability Testing</b> .....          | 24 |
| <b>Recommended Solder Profile</b> .....                 | 25 |

## General Information

**HPL - H44 X<sub>1</sub>X<sub>2</sub>1C0**



### X<sub>1</sub>:Lens & Assembly Type-

R : 60° Lens Emitter only  
T : 60° Lens Emitter on Standard Star

### X<sub>2</sub>:Color-

U: UV390~420nm

### Power-

C: 3W



## Part Number Matrix

| Type<br>Wavelength | 60°Lens      | 60°Lens & Star |
|--------------------|--------------|----------------|
| U                  | HPL-H44RU1C0 | HPL-H44TU1C0   |

## Absolute Maximum Ratings

(T<sub>j</sub>=25°C)

| Parameter                                                       | Symbol                 | Rating              | Unit |
|-----------------------------------------------------------------|------------------------|---------------------|------|
| Power Dissipation<br>UV390-420nm                                | P                      | 3                   | W    |
| Forward Current                                                 | I <sub>F</sub>         | 700                 | mA   |
| Forward Pulse Current<br>(1/10 Duty Cycle, 400msec Pulse Width) | I <sub>FP</sub>        | 1000                | mA   |
| Thermal Resistance, Junction-Case                               | R <sub>th</sub> , J-C1 | 5                   | °C/W |
| LED Junction Temperature                                        | T <sub>J</sub>         | 125                 | °C   |
| Operating Temperature Range                                     | T <sub>opr</sub>       | - 40°C to + 80°C    |      |
| Storage Temperature Range                                       | T <sub>stg</sub>       | - 40°C to + 120°C   |      |
| Soldering Condition                                             | T <sub>sol</sub>       | 260°C For 5 Seconds |      |

Note: 1. The thermal resistance value is measured with MCPCB (Star).

## Initial Electrical/Optical Characteristics

- **Forward Voltage**  $(T_j=25^\circ C)$

| Wavelength | Forward Voltage |      |      |      |               | Test Condition | Unit |
|------------|-----------------|------|------|------|---------------|----------------|------|
|            | Symbol          | MIN. | TYP. | MAX. |               |                |      |
| 390~420nm  | $V_F$           | 3.03 | 3.8  | 4.47 | $I_F = 700mA$ |                | V    |

**Caution:** The real output is decided by chip capability

- **Radiant Flux**  $(T_j=25^\circ C)$

| Wavelength | Radiant Flux |      |      |      |  | Test Condition | Unit |
|------------|--------------|------|------|------|--|----------------|------|
|            | Symbol       | MIN. | TYP. | MAX. |  |                |      |
| 410~420nm  | $\Phi_e$     | 500  | 850  | -    |  | $I_F = 700mA$  | mW   |
| 400~410nm  |              | 500  | 850  | -    |  |                |      |
| 390~400nm  |              | 500  | 850  | -    |  |                |      |

**Caution:** The real output is decided by chip capability

- **Peak wavelength**  $(T_j=25^\circ C)$

| Wavelength | Wavelength  |      |      |      |               | Test Condition | Unit |
|------------|-------------|------|------|------|---------------|----------------|------|
|            | Symbol      | MIN. | TYP. | MAX. |               |                |      |
| 390~420nm  | $\lambda_p$ | 390  | -    | 420  | $I_F = 700mA$ |                | nm   |

- **Spectra half-width**  $(T_j=25^\circ C)$

| Wavelength | Wavelength      |      |      |      |               | Test Condition | Unit |
|------------|-----------------|------|------|------|---------------|----------------|------|
|            | Symbol          | MIN. | TYP. | MAX. |               |                |      |
| 390~420nm  | $\Delta\lambda$ | -    | 15   | -    | $I_F = 700mA$ |                | nm   |

- Typical Radiation Pattern

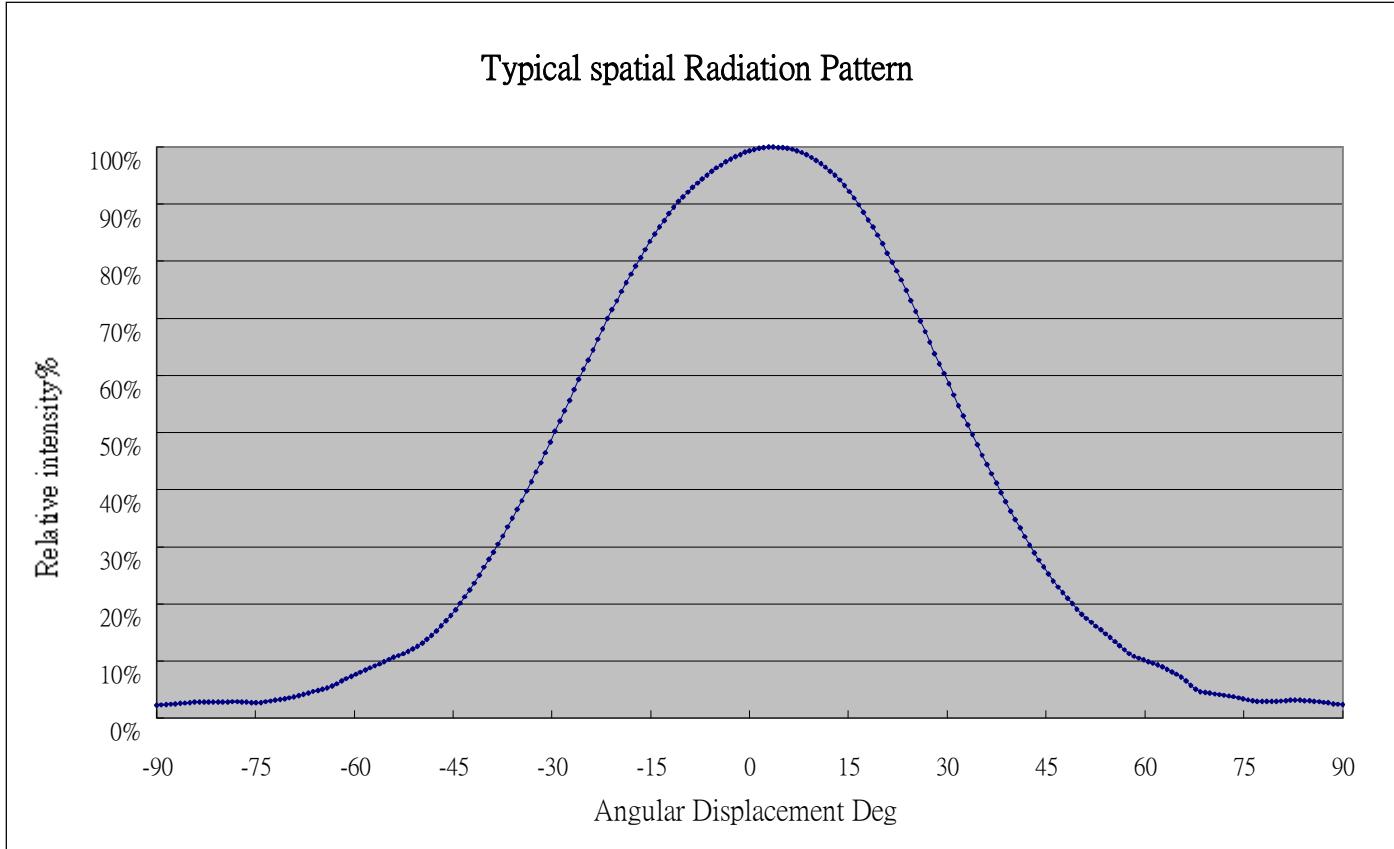


Fig. (60° Lens) Typical Representative Spatial Radiation Pattern

- Bin Code List for Reference

 (T<sub>j</sub>=25°C)

| Item                         | Bin Code | Symbol         | Condition                 | Min. | Max. | Unit |
|------------------------------|----------|----------------|---------------------------|------|------|------|
| Forward Voltage <sup>1</sup> | H        | V <sub>F</sub> | I <sub>F</sub> = 700 [mA] | 3.03 | 3.27 | V    |
|                              | J        |                |                           | 3.27 | 3.51 |      |
|                              | K        |                |                           | 3.51 | 3.75 |      |
|                              | L        |                |                           | 3.75 | 3.99 |      |
|                              | M        |                |                           | 3.99 | 4.23 |      |
|                              | N        |                |                           | 4.23 | 4.47 |      |
| Radiant Flux <sup>2</sup>    | D        | Φ <sub>e</sub> | I <sub>F</sub> = 700 [mA] | 350  | 425  | mW   |
|                              | E        |                |                           | 425  | 500  |      |
|                              | F        |                |                           | 500  | 600  |      |
|                              | G        |                |                           | 600  | 700  |      |
|                              | H        |                |                           | 700  | 800  |      |
|                              | J        |                |                           | 800  | 900  |      |

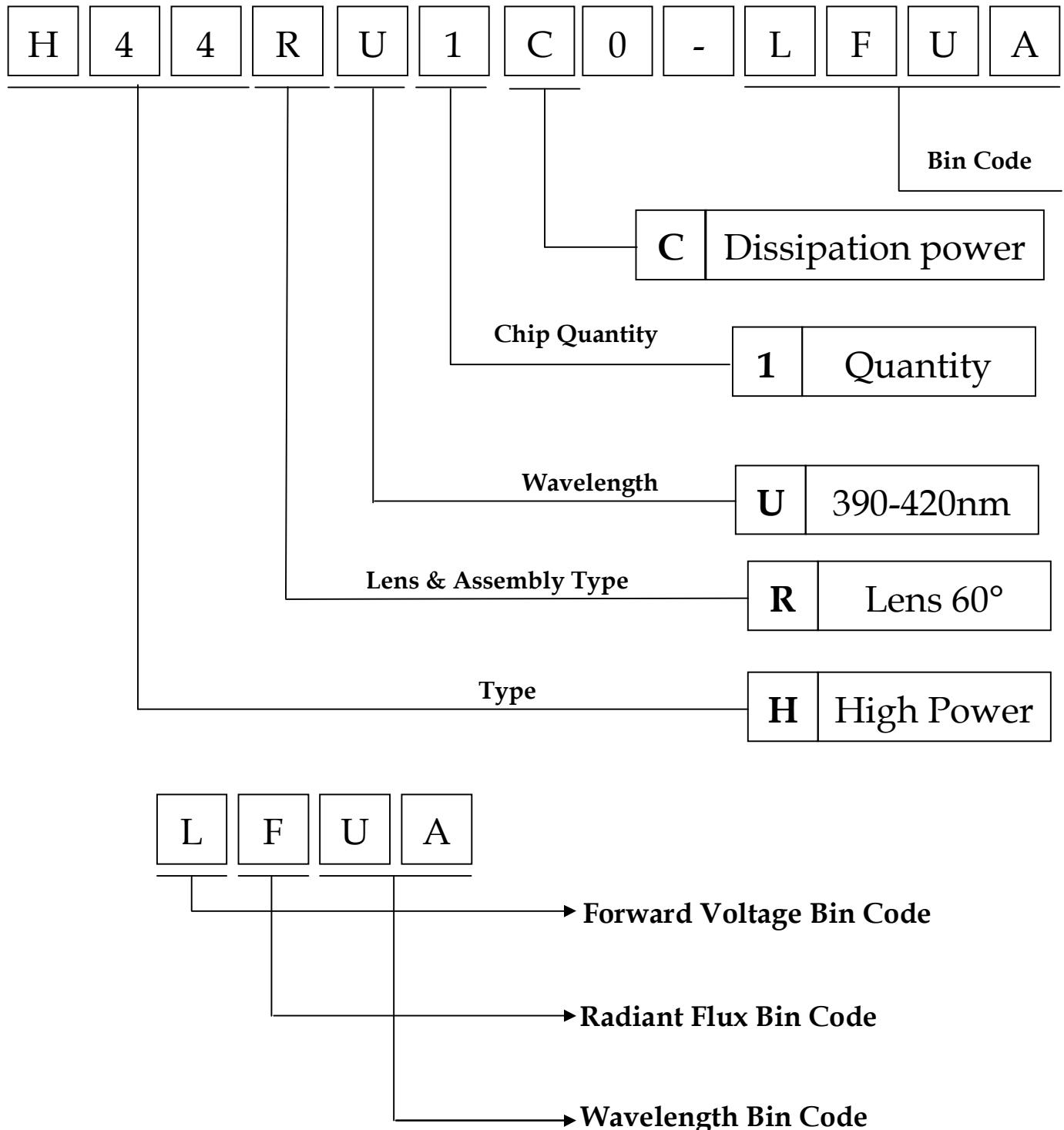
- Wavelength Bins

| Wavelength <sup>3</sup> | Bin Code | Symbol         | Condition                 | Min. | Max. | Unit |
|-------------------------|----------|----------------|---------------------------|------|------|------|
| U 390~420nm             | UF       | λ <sub>p</sub> | I <sub>F</sub> = 700 [mA] | 415  | 420  | nm   |
|                         | UE       |                |                           | 410  | 415  |      |
|                         | UD       |                |                           | 405  | 410  |      |
|                         | UC       |                |                           | 400  | 405  |      |
|                         | UB       |                |                           | 395  | 400  |      |
|                         | UA       |                |                           | 390  | 395  |      |

## Note

- Forward voltage measurement allowance is ± 0.1V.
- Radiant flux measurement allowance is ± 10%.
- Wavelength measurement allowance is ± 2nm.

## Part Number Formation



## Characteristic Diagram

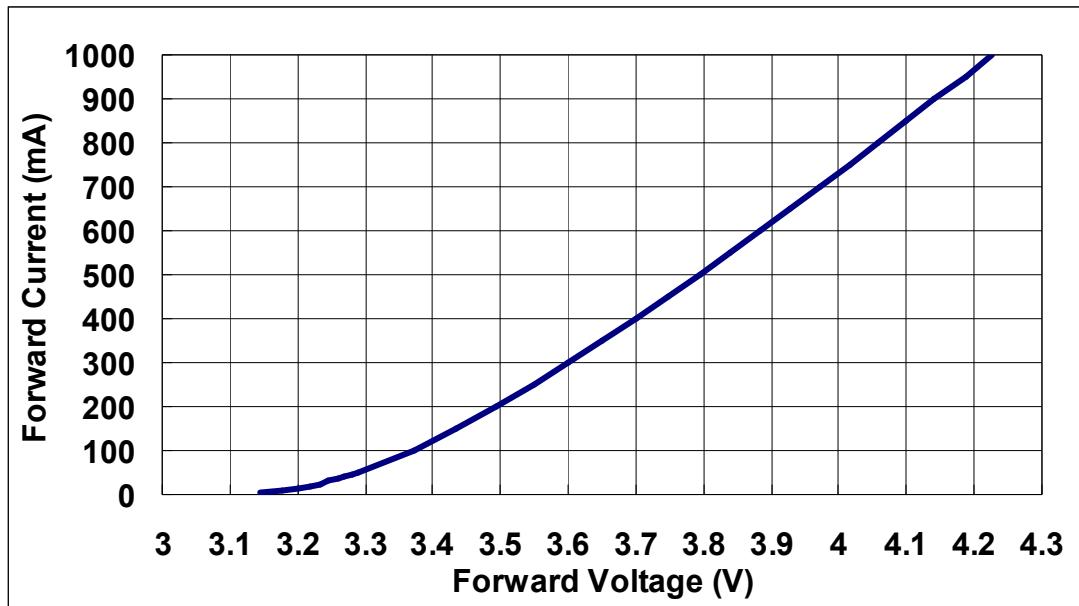


Fig. Forward Current vs. Forward Voltage

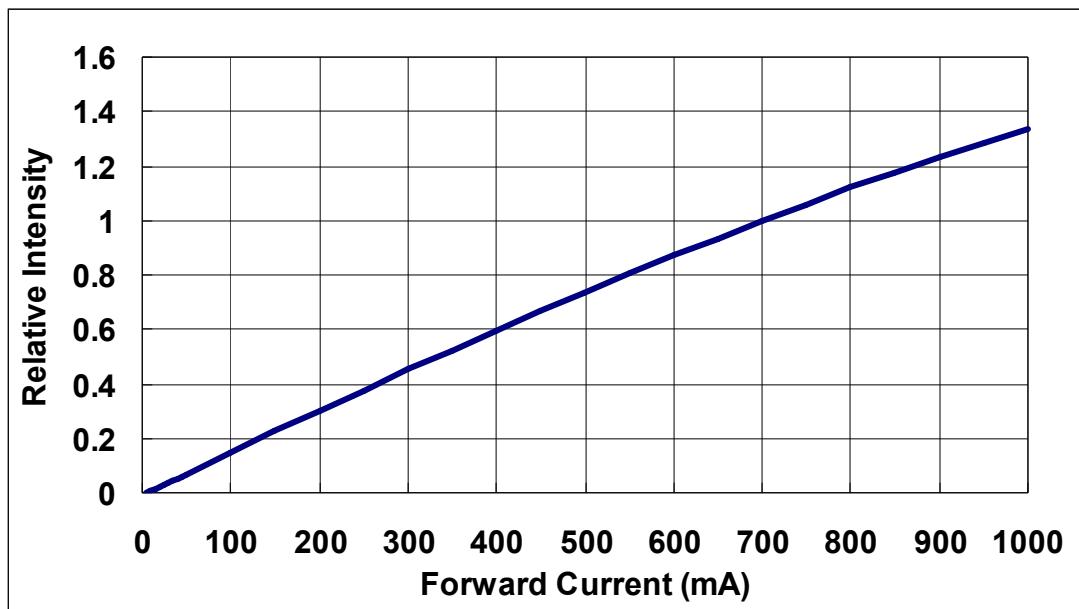


Fig. Relative Intensity vs. Forward Current.

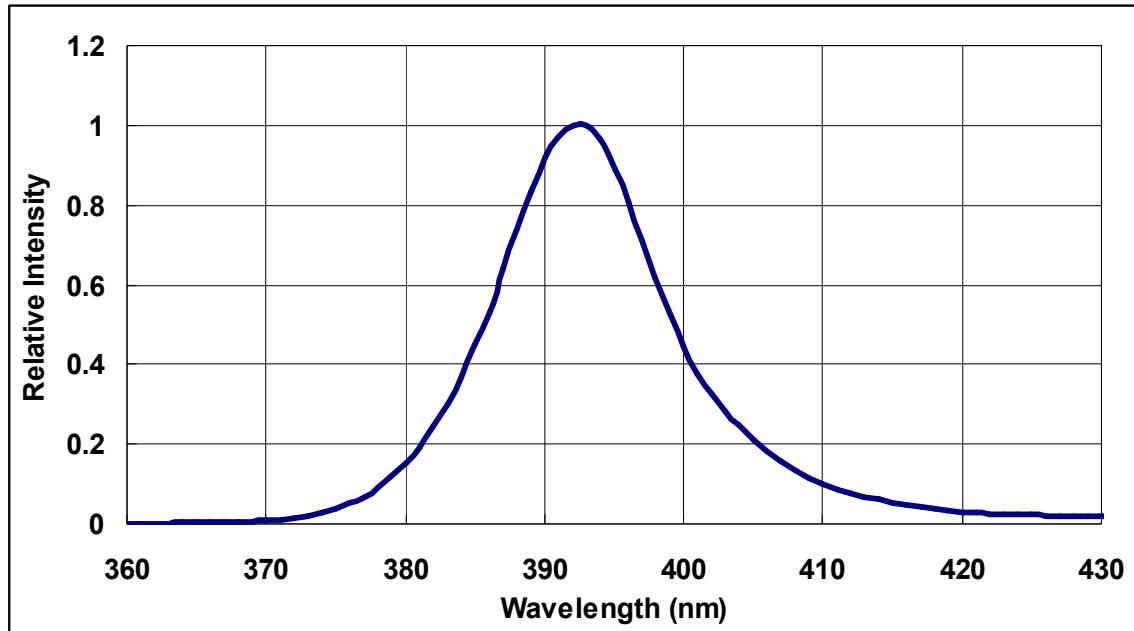


Fig. Typical Relative Intensity vs. wavelength

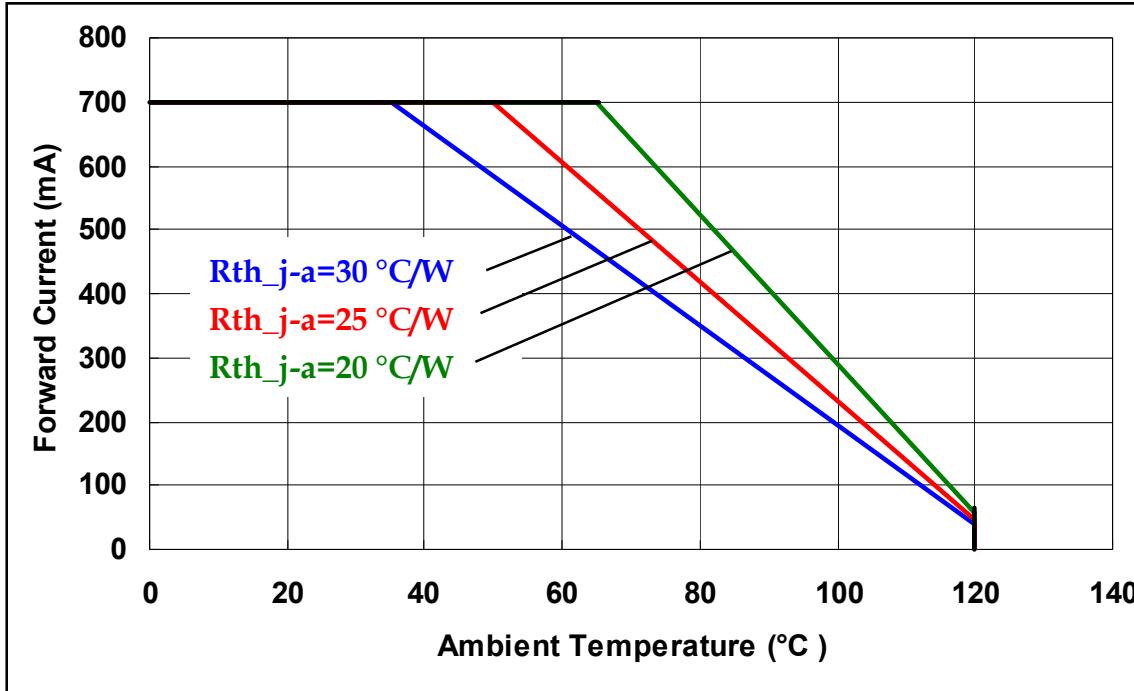


Fig. Forward Current Degrading Curve

Note:

R<sub>th</sub><sub>j-a</sub> : junction to Ambient Thermal Resistance

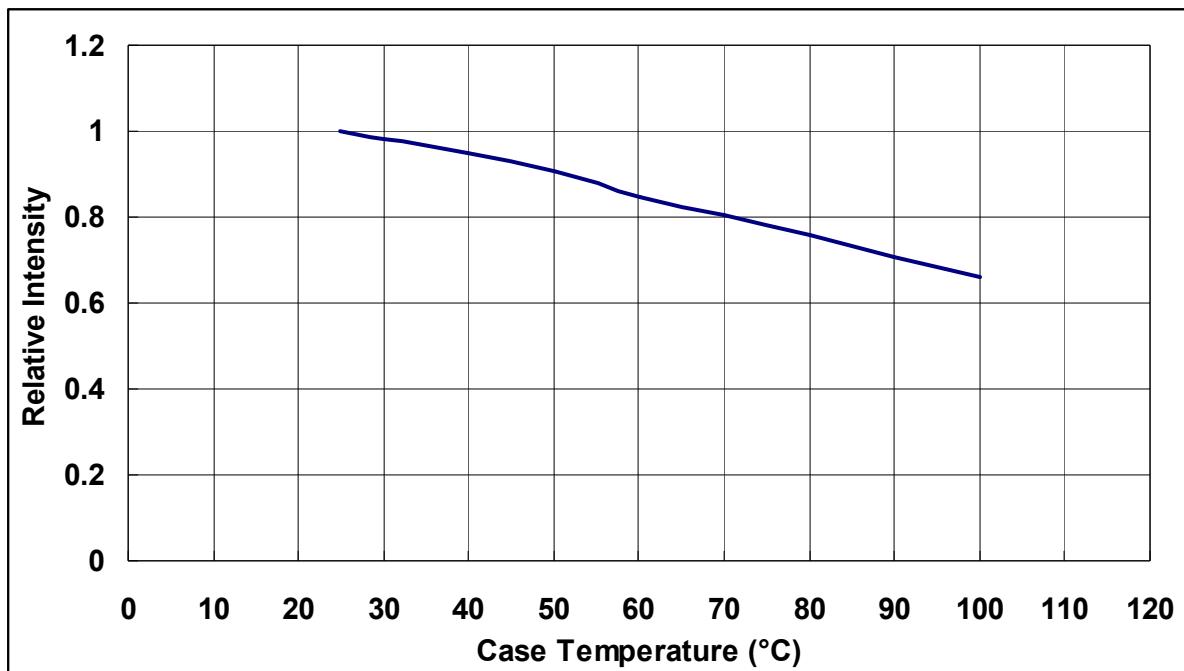


Fig. Relative Intensity vs. Case Temperature

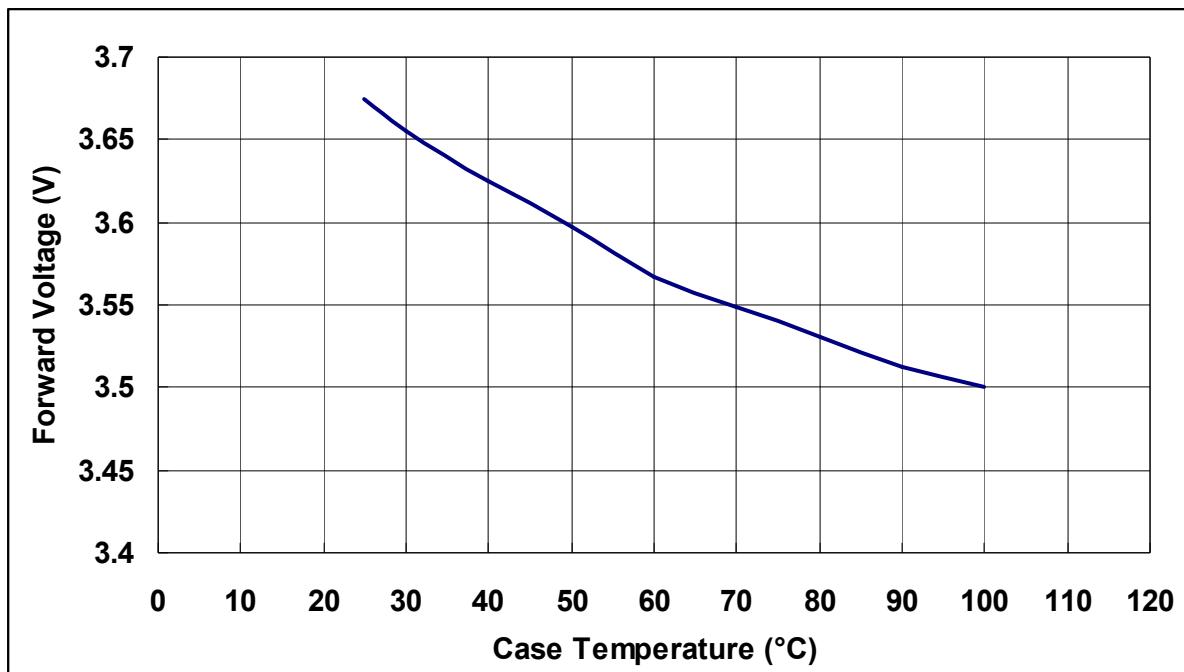


Fig. Forward Voltage vs. Case Temperature

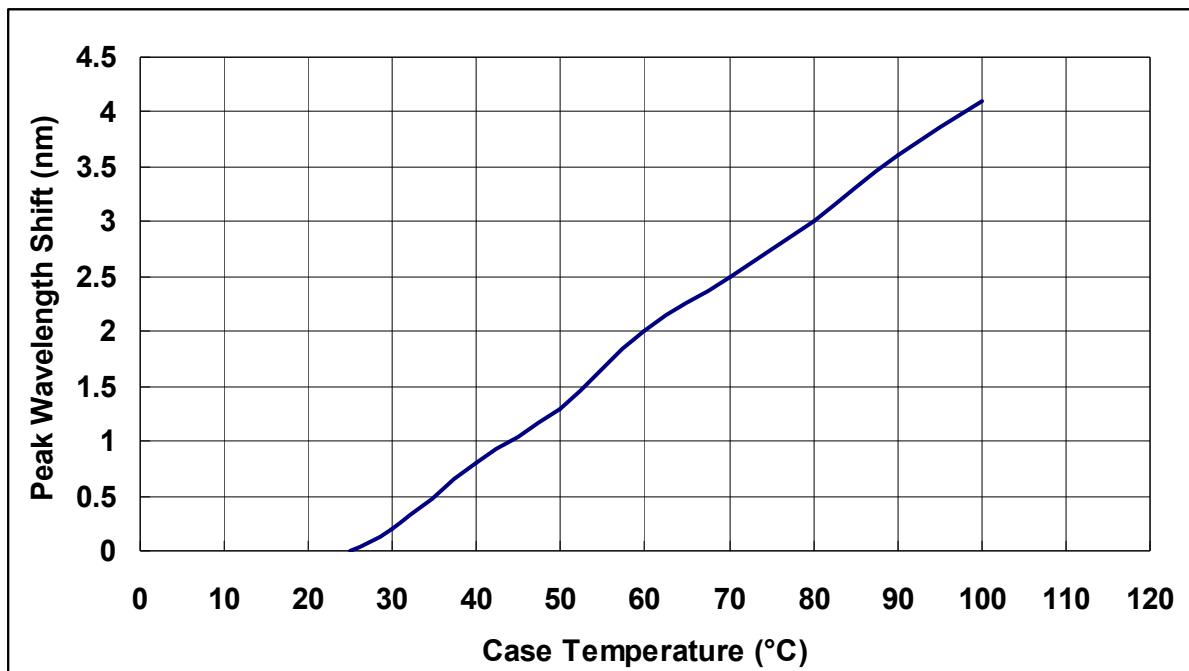
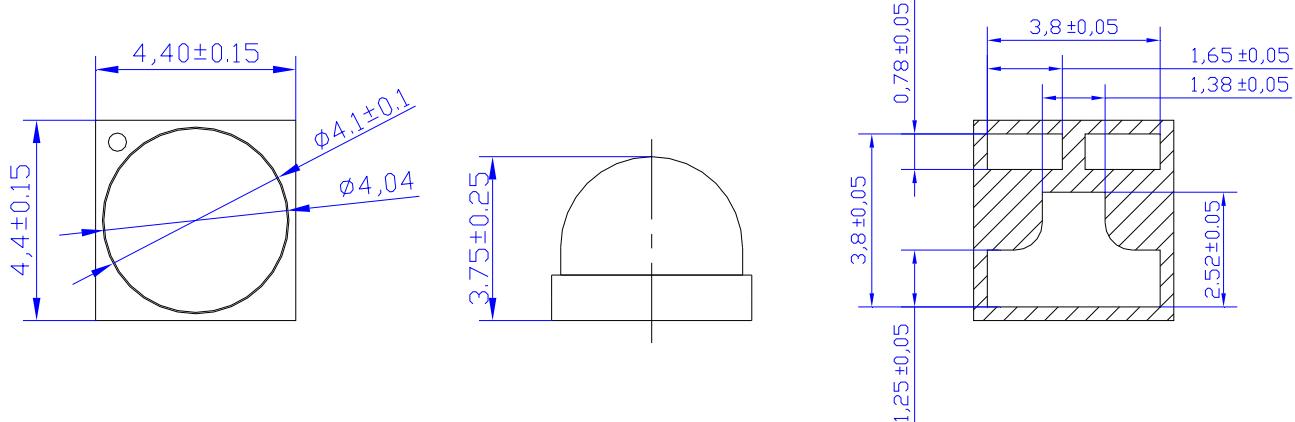


Fig. Peak Wavelength shift vs. Case Temperature

## Outline Dimension

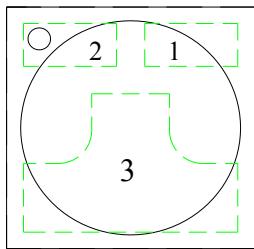
**HPL-H44RU1C0**

**Unit : mm**

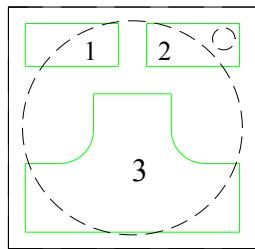


**Fig. Package Outline Drawing.**

## Pad Configuration



**TOP**



**BOTTOM**

| <b>PAD</b> | <b>Function</b> |
|------------|-----------------|
| 1          | <b>Cathode</b>  |
| 2          | <b>Anode</b>    |
| 3          | <b>Thermal</b>  |

**Fig. Pad configuration.**

### HPL-H44TU1C0

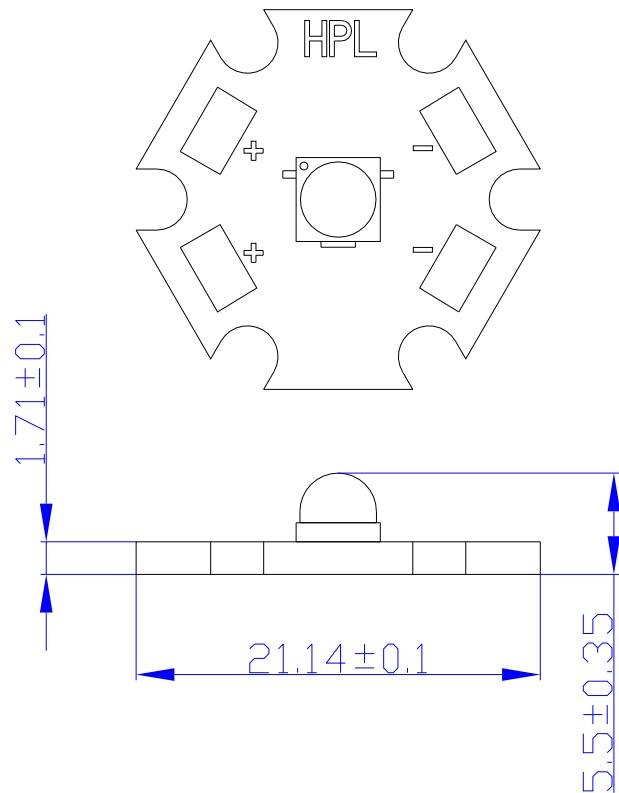
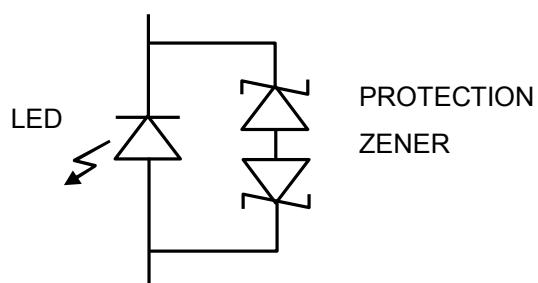
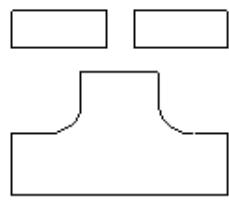
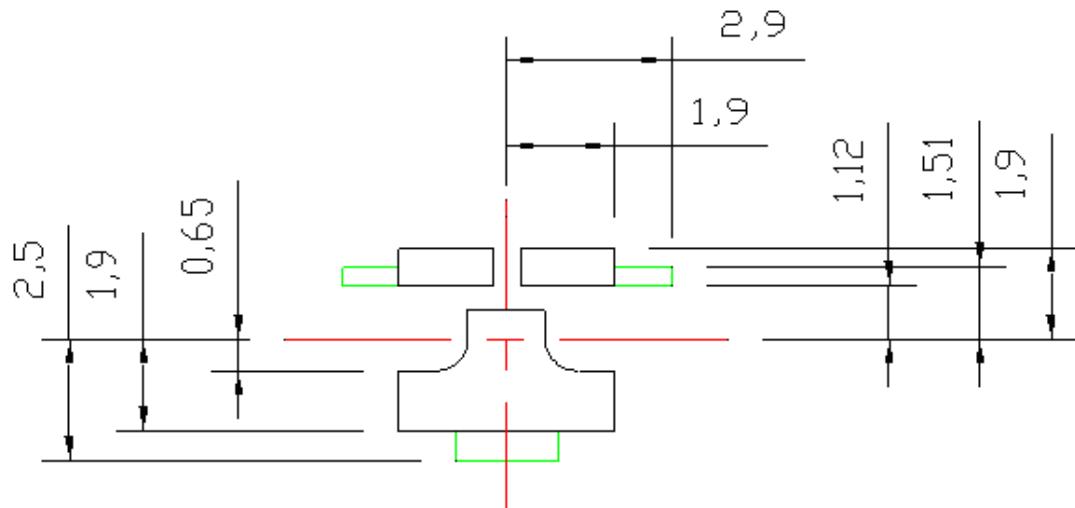


Fig. Assembly r Outline Drawing.

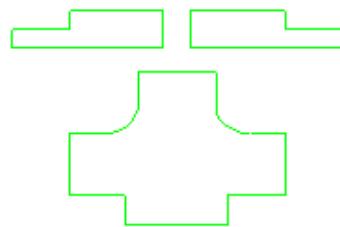
### PROTECTION CIRCUIT



## Recommended Solder Pattern



**SOLDER  
MASK**



**COPPER  
LAYER**

Fig. Solder Pad Layout.

## Shipping Package Style

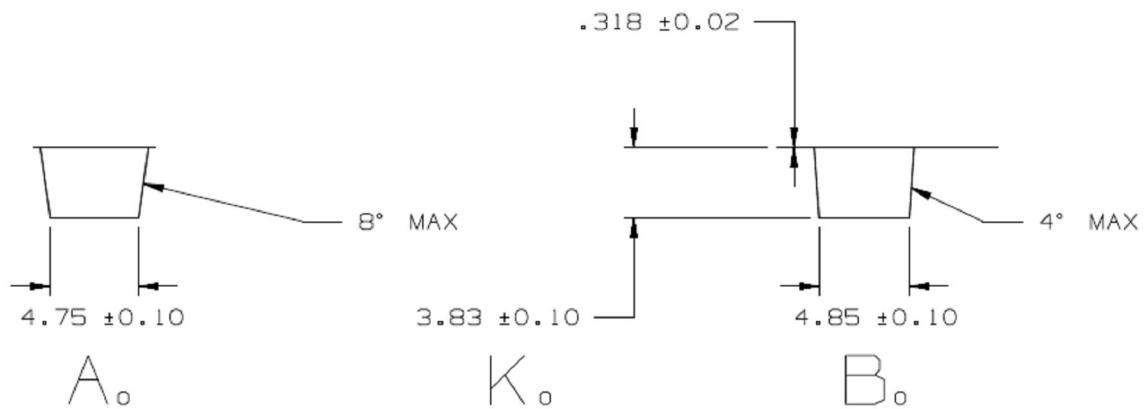
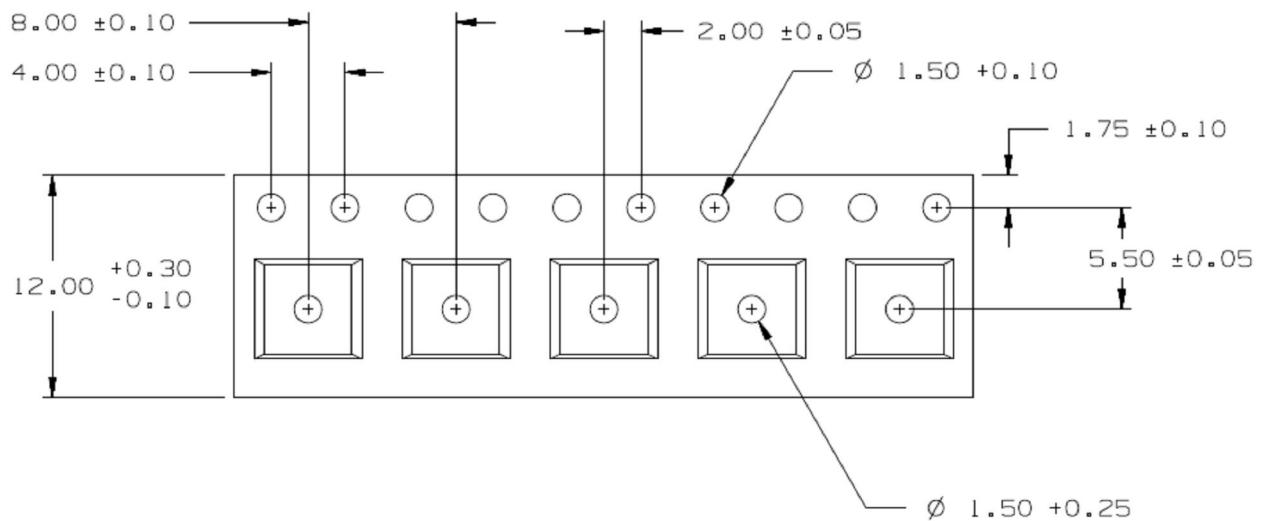
### Lens Type

#### Tapping Dimension Packaging Specification

##### 60 Degree Lens Type :

- Moisture proof bag.
- 1 Reel/bag.
- Q'ty: 650 (MAX)/Reel.

Unit : mm



## Label Formation

|                       |                         |
|-----------------------|-------------------------|
| P/N: XXXXXXXXXXXXXXXX | BIN Rank : XXXXXXXXXXXX |
| LOT: XXXXXXXXXXXXXXXX | Q'ty : XXXX PCS XXX     |

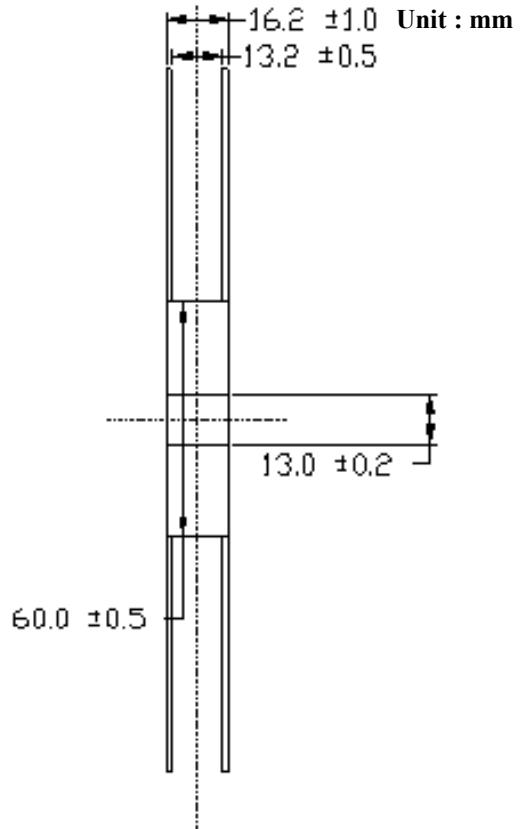
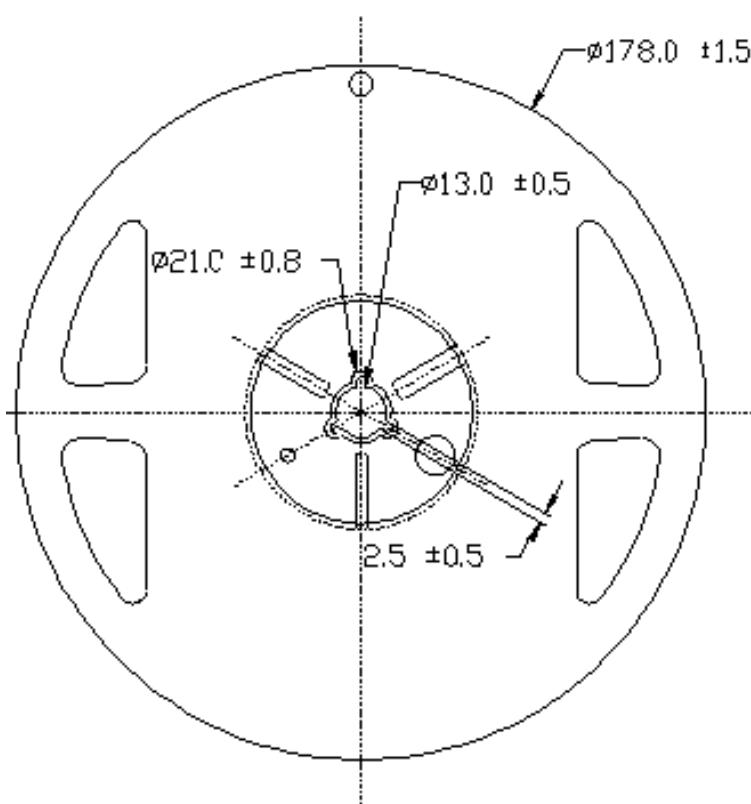
75mm\*8mm

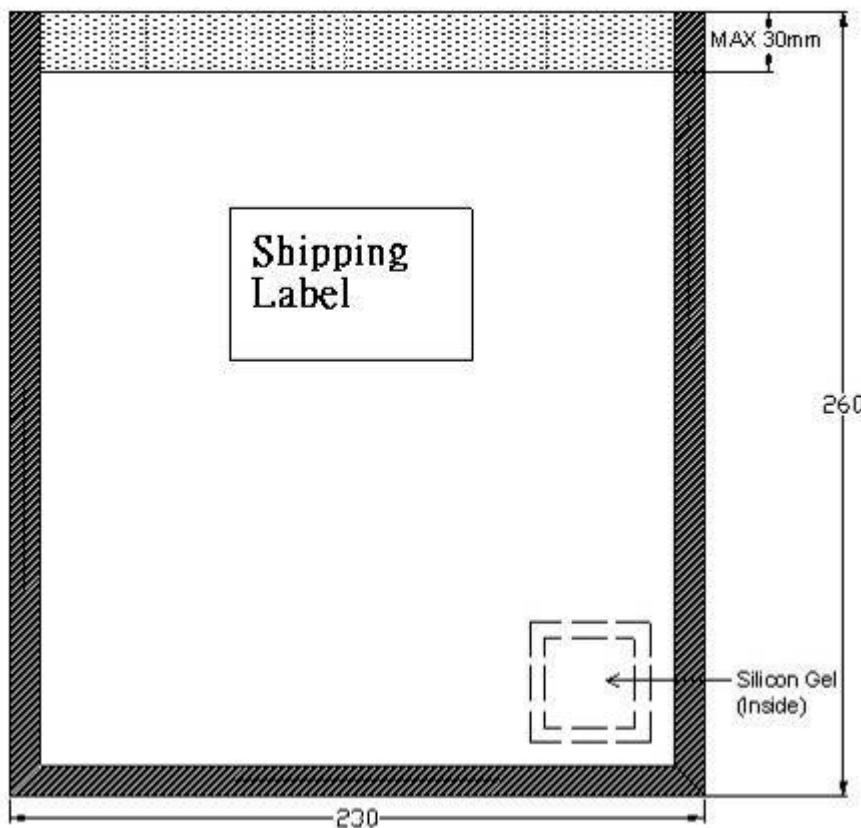
## Package

| Box Type      | Dimension (mm) | Reel/Box    | 60°Lens Type (Pcs) |
|---------------|----------------|-------------|--------------------|
| Small Box(S)  | 230x85x265     | 5 Reel/Box  | 3250               |
| Middle Box(M) | 470x265x270    | 30 Reel/Box | 19500              |
| Large Box(L)  | 470x435x270    | 50 Reel/Box | 32500              |

## Reel Packaging :

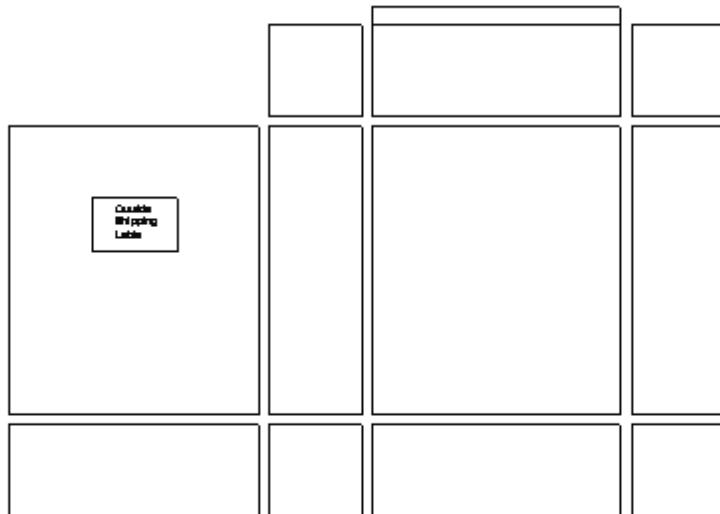
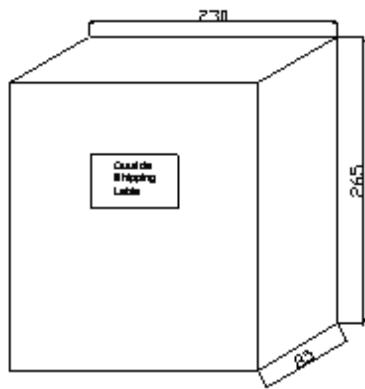
### Reel Part :



**Anti Statistic Bag :****Unit : mm**

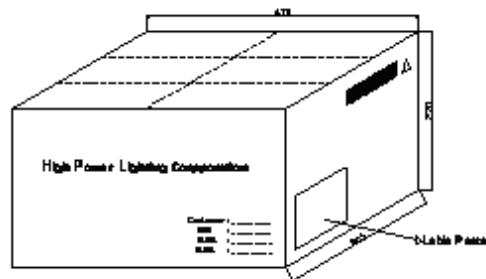
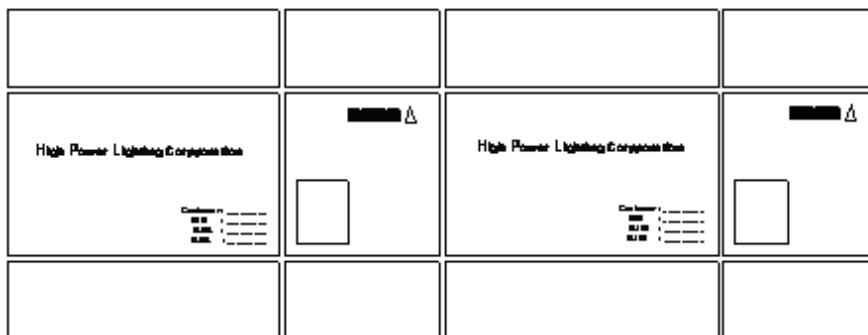
### Small Box

Unit : mm



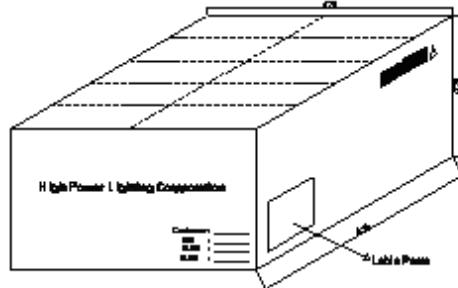
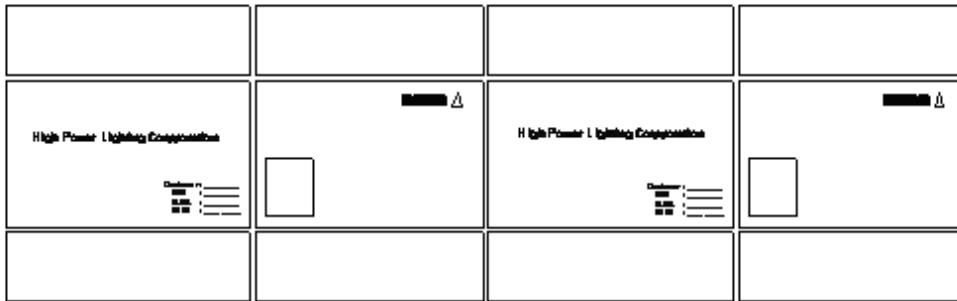
### Middle Box

Unit : mm



## Large Box

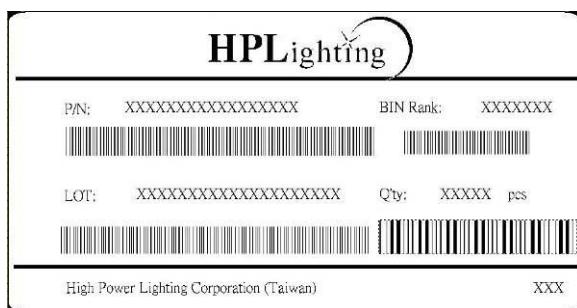
Unit : mm



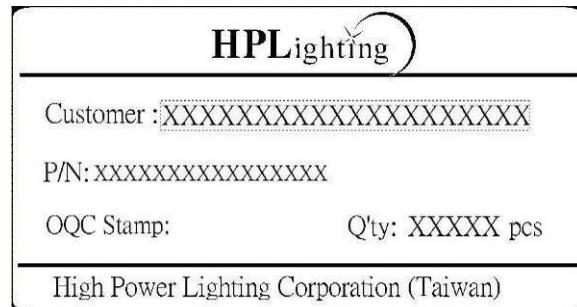
## Label Formation

70mm

Unit : mm



40mm



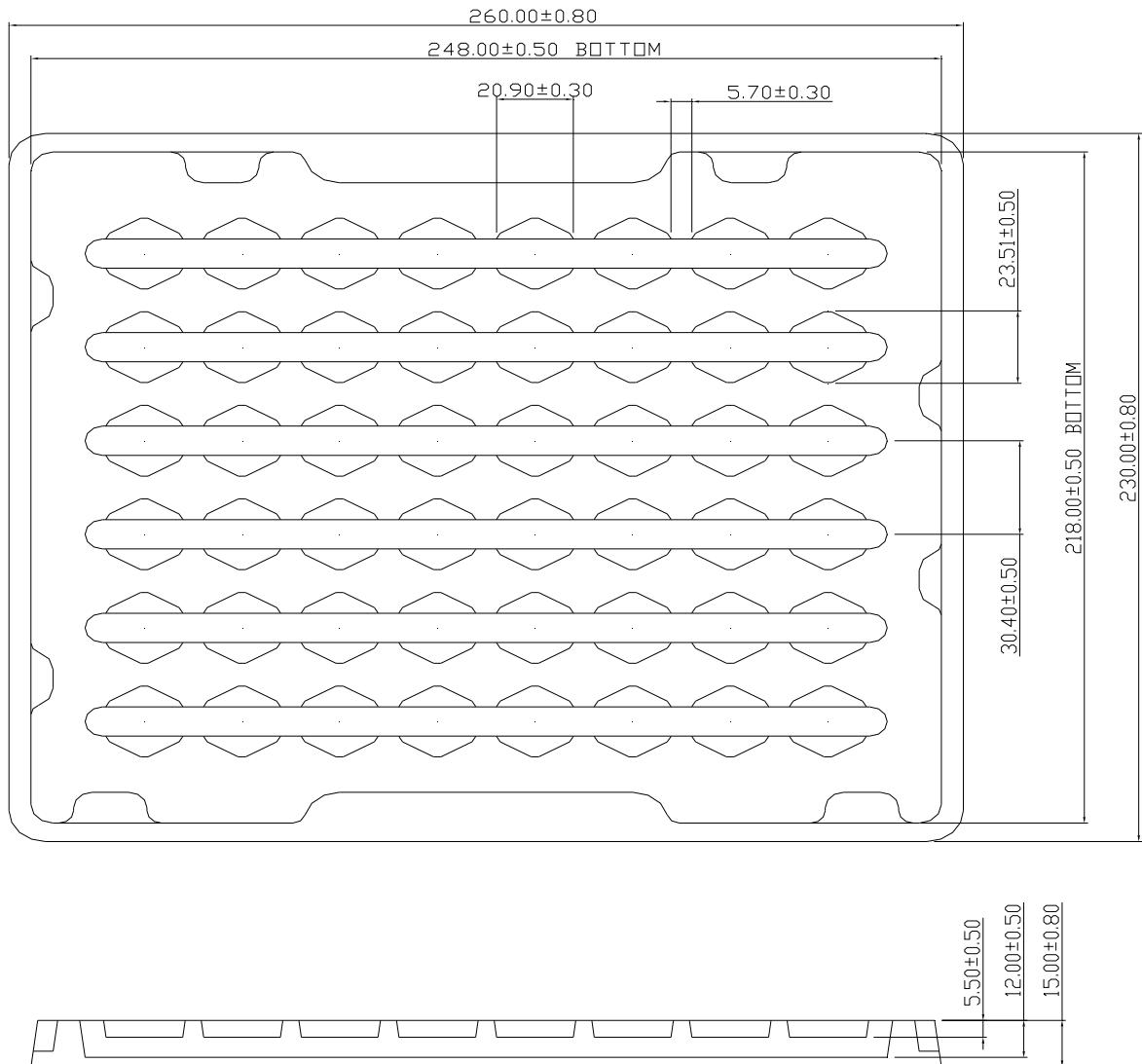
## Assembly Type

### Tapping Dimension Packaging Specification

#### 60 Degree Assembly Type :

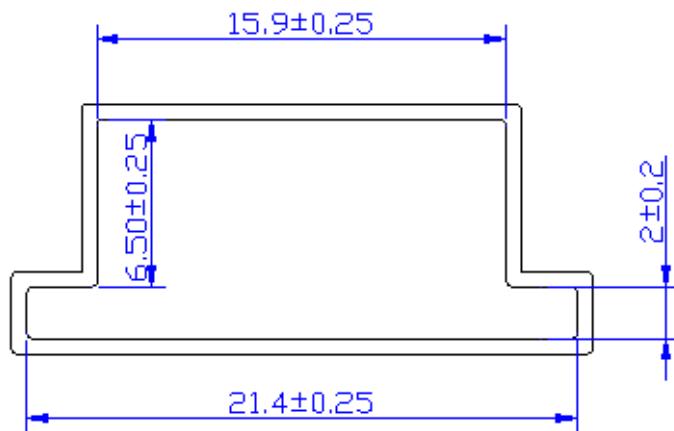
- Moisture proof bag.
- 21 Tray (MAX) /bag.
- Q'ty: 48pcs(MAX)/Tray

**Unit : mm**



**60 Degree Assembly Type :**

- 1 Tube
- Q'ty:20pcs(MAX)/Tube
- Q'ty: 300 Tube (MAX)/Box

**Unit : mm****NOTES:**

General tolerance=± 0.25mm

Material:PVC,Clear

THICKNESS : 0.60±0.1

LENGTH : 424±2mm

**Label Formation**

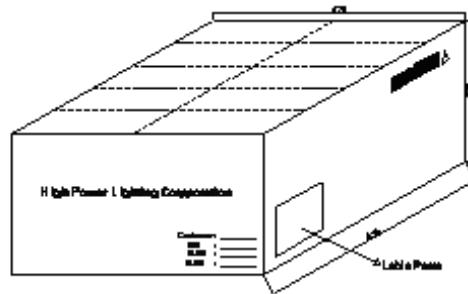
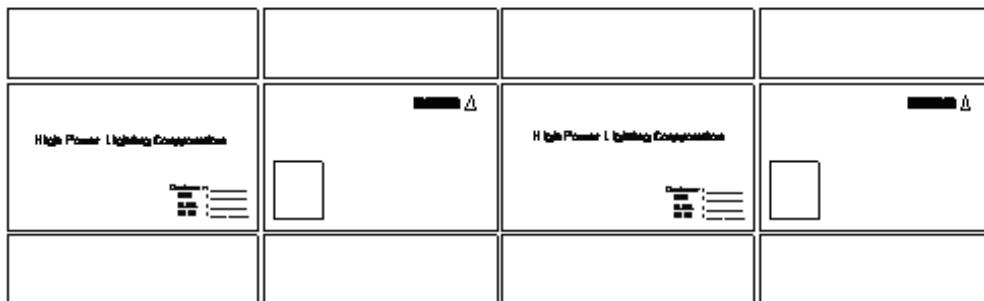
|                       |                       |
|-----------------------|-----------------------|
| P/N: XXXXXXXXXXXXXXXX | BIN Rank : XXXXXXXXXX |
| LOT: XXXXXXXXXXXXXXXX | Q'ty : XXXX PCS XXX   |

75mm\*8mm



## Package Large Box

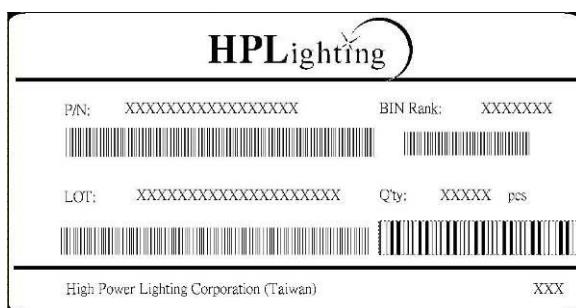
Unit : mm



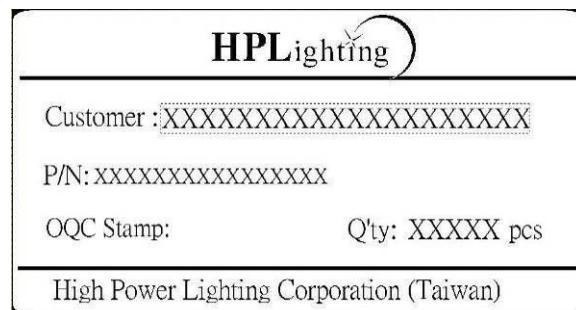
## Label Formation

70mm

Unit : mm



40mm

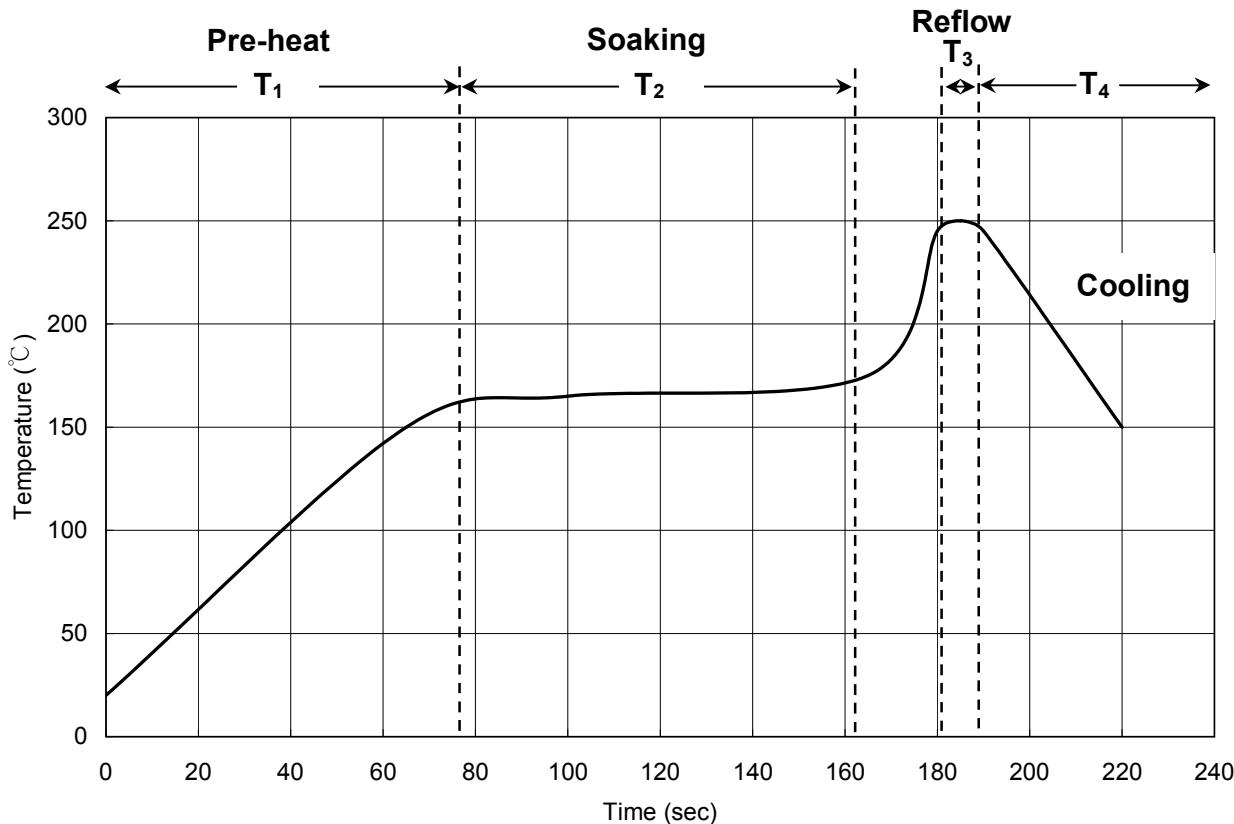


## Qualification Reliability Testing

| Classification     | Test Item                              | Test conditions                                                                                    | Reference Standard                                                             |
|--------------------|----------------------------------------|----------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------|
| Endurance Test     | Operation Life                         | I <sub>f</sub> = 60mA/120mA(H28), 350mA/700mA(H40/H44/H99)<br>Ta = 25°C<br>Test Duration = 1000hrs | MIL-STD-750: 1026<br>MIL-STD-883: 1005<br>JIS C 7021: B-1                      |
|                    | High Temperature High Humidity Storage | Ta = 85±5°C<br>RH = 85±5%<br>Test Duration = 1000hrs                                               | MIL-STD-202: 103B<br>JIS C 7021: B-11                                          |
|                    | High Temperature Storage               | Ta = 105±5°C<br>Test Duration = 1000hrs                                                            | MIL-STD-202: 1008<br>JIS C 7021: B10                                           |
|                    | Low Temperature Storage                | *Ta = -40±5°C<br>Test Duration = 1000hrs                                                           | JISC 7021: B-12                                                                |
| Environmental Test | Temperature Cycling                    | -40°C ~ 25°C ~ 105°C ~ 25°C<br>30min 5min 30min 5min<br>Test Duration = 10 cycle                   | MIL-STD-202: 107D<br>MIL-STD-750: 1051<br>MIL-STD-883: 1010<br>JIS C 7021: A-4 |
|                    | Thermal Shock                          | -55±5°C ~ 105±5°C<br>30min 30min<br>Test Duration = 10 cycle                                       | MIL-STD-202: 107D<br>MIL-STD-750: 1051<br>MIL-STD-883: 1011                    |
|                    | Solder Resistance                      | Tsol = 260±5°C<br>Dwell Time = 10sec                                                               | MIL-STD-202: 210A<br>MIL-STD-750: 2031<br>JIS C 7021: A-1                      |
| Measuring Items    | Symbol                                 | Measuring Conditions                                                                               | Failure Criteria                                                               |
| Forward voltage    | V <sub>f</sub>                         | I <sub>f</sub> = 60mA/120mA(H28), 350mA/700mA(H40/H44/H99)                                         | V <sub>f</sub> shift > 10%                                                     |
| Luminous           | IV%                                    | I <sub>f</sub> = 60mA/120mA(H28), 350mA/700mA(H40/H44/H99)                                         | I <sub>v</sub> % shift > 10%                                                   |

## Recommended Solder Profile

**Soldering** Recommended soldering conditions:



|                      |                            |                   |
|----------------------|----------------------------|-------------------|
| <b>T<sub>1</sub></b> | Ramp up rate               | 1.0 ~ 3.0 °C /sec |
|                      | Pre-heat time              | 50 ~ 80 sec       |
| <b>T<sub>2</sub></b> | Soaking temperature        | 155 ~ 185 °C      |
|                      | Dwell time during soaking  | 60 ~ 120 sec      |
| <b>T<sub>3</sub></b> | Reflow temperature         | 240 ~ 250 °C      |
|                      | Reflow time                | Max 10 sec        |
| <b>T<sub>4</sub></b> | Ramp up rate during reflow | 1.2 ~ 2.3 °C /sec |
|                      | Cooling                    | 1.0 ~ 6.0 °C /sec |

Note: Suggest using Sn96Ag3Cu0.5 lead free solder.

### Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED if necessary.



**This page is intended left blank.**

**For the latest product information, call us or visit: [www.hplighting.com.tw](http://www.hplighting.com.tw)**

©2015, High Power Lighting Corporation(HPL), all rights reserved. This document contains information that is proprietary to HPL and may be duplicated in whole or in part by the original recipient for the internal business purposes only, provided that this entire notice appears in all copies. In accepting this document, the recipient agrees to make every reasonable effort to prevent unauthorized use of this information.

5F, No 173-8, Yung-Fon Road, Tu-Cheng District, New Taipei City, Taiwan, R.O.C.  
TEL: +886-2-8262-8886      FAX : +886-2-8262-8885

**HPLighting Corp.**

[www.hplighting.com.tw](http://www.hplighting.com.tw)

The information in this document is subject to change without notice.

**HPL-H44RU1CO**

- 26/26 --